TE Internal #: 1926017-1

Rectangular Power Connectors, Header, Plug, Wire-to-Board, 32

Position, 4.5 mm / 2.5 mm [.177 in / .098 in] Centerline, Printed

Circuit Board

View on TE.com >

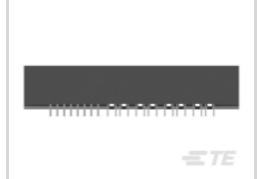


Connectors > Power Connectors > Rectangular Power > Rectangular Power Connectors











Rectangular Power Connector Type: Header

Connector & Housing Type: Plug
Connector System: Wire-to-Board

Number of Positions: 32

Centerline (Pitch): 2.5 mm, 4.5 mm [.098 in, .177 in]

Features

Product Type Features

Header Type	Fully Shrouded
Rectangular Power Connector Type	Header
Connector & Housing Type	Plug
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	32
PCB Mount Orientation	Right Angle
Number of Power Positions	8
Number of Signal Positions	24
Number of Rows	3

Electrical Characteristics

Operating Voltage	60 VDC	



Contact Features

Contact Mating Area Plating Material	Gold
Contact Retention Within Housing	Without
Contact Type	Pin
PCB Contact Termination Area Plating Material	Tin

Termination Features

Termination Method to Wire & Cable	Crimp
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Connector Mounting Type	Board Mount	
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Housing Features

Centerline (Pitch)	2.5 mm, 4.5 mm[.098 in][.177 in]
Housing Color	Black
Housing Material	Polyphthalamide

Dimensions

Row-to-Row Spacing	2.5 mm[.098 in]
Now-to-Now spacing	2.3 [[[[[.070 [[]]

Operation/Application

Industry Standards

UL Flammability Rating	UL 94V-0
Glow Wire Rating	Standard Part - Not Glow Wire

Packaging Features

Packaging Method	Bulk	
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224)



$D_{\alpha\alpha\alpha}$	not contain	DE V CH	SVILIC
DOES	not contain	KEACH	SVHU

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per
	homogenous material. Also BFR/CFR/PVC
	Free

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought

















Documents

Product Drawings

PIN Connector Straight Solder Tails

English

CAD Files

Customer View Model

ENG_CVM_CVM_1926017-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1926017-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1926017-1_B.3d_stp.zip

English

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Product Specifications

Application Specification

English